## **MECHANICAL CASE OUTLINE**

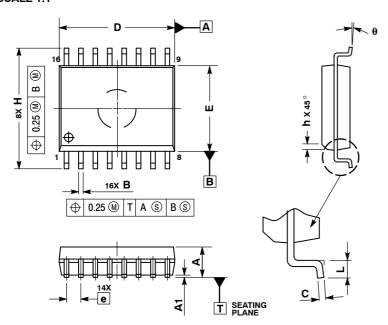
**PACKAGE DIMENSIONS** 



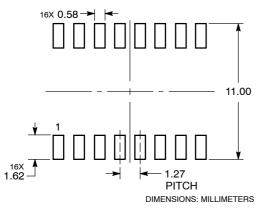


SOIC-16 WB CASE 751G-03 ISSUE D

**DATE 12 FEB 2013** 



## **SOLDERING FOOTPRINT**



- NOTES:

  1. DIMENSIONS ARE IN MILLIMETERS.

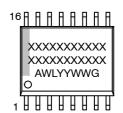
  2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

  3. DIMENSIONS D AND E DO NOT INLCUDE MOLD PROTRUSION.

  4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

MILLIN	IETERS
MIN	MAX
2.35	2.65
0.10	0.25
0.35	0.49
0.23	0.32
10.15	10.45
7.40	7.60
1.27	BSC
10.05	10.55
0.25	0.75
0.50	0.90
0 °	7 °
	MIN 2.35 0.10 0.35 0.23 10.15 7.40 1.27 10.05 0.25 0.50

## **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code

= Assembly Location

= Wafer Lot WL = Year VV ww = Work Week = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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ISSUE	REVISION	DATE			
С	ADDED MARKING DIAGRAM. REQ. BY S. FARRETTA	30 APR 2004			
D	ADDED SOLDER FOOTPRINT. REQ. BY I. MARIANO.	12 FEB 2013			
	-	•			

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